1-1452228-9 ACTIVE

AMP | LEAVYSEAL

TE Internal #: 1-1452228-9

PCB Mount Header, Vertical, Wire-to-Board, 92 Position, 4 mm [. 157 in] Centerline, Fully Shrouded, Silver, Through Hole - Solder, Sealable, LEAVYSEAL

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > LEAVYSEAL Headers



Connector System: Wire-to-Board

Number of Positions: 92

Centerline (Pitch): 4 mm [.157 in]

Sealable: Yes

PCB Mount Orientation: Vertical

All LEAVYSEAL Headers (13)

Features

Product Type Features

Mixed & Hybrid Header	No
Connector Shape	Rectangular
PCB Connector Assembly Type	PCB Mount Header
Header Type	Fully Shrouded
Connector System	Wire-to-Board
Sealable	Yes

Configuration Features

Number of Sections	1
Number of Signal Positions	92
Number of Positions	92
PCB Mount Orientation	Vertical
Number of Rows	4

Body Features

Primary Product Color	Black
Connector & Keying Code	A

Contact Features



Contact Size	1.5mm
Contact Type	Tab
Mating Tab Width	1.5 mm[.059 in]
Mating Tab Thickness	.64 mm[.025 in]
Contact Mating Area Plating Material	Silver
Contact Current Rating (Max)	20 A
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mounting Holes	Without
Mating Alignment Type	Keyed
Mating Alignment	With
PCB Mount Alignment	With
Panel Mount Feature	Without
PCB Mount Retention	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	4 mm[.157 in]
Dimensions	
Connector Length	120 mm[4.72 in]
Connector Width	43.5 mm[1.71 in]
Profile Height from PCB	48 mm[1.88 in]
Operation/Application	
Shielded	No
Circuit Application	Signal
Packaging Features	
Packaging Type	Tray
Packaging Quantity	16

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant	
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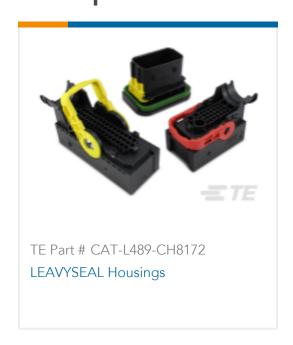


EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

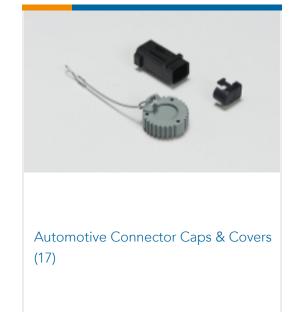
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | LEAVYSEAL

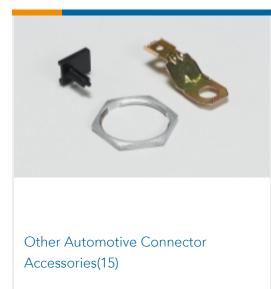








Insertion & Extraction Tools(5)







Customers Also Bought

















Documents

Product Drawings

TAB HEADER 92POS.

English

CAD Files

Customer View Model

ENG_CVM_CVM_1-1452228-9_C.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-1452228-9_C.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-1452228-9_C.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

PCB Mount Header, Vertical, Wire-to-Board, 92 Position, 4 mm [.157 in] Centerline, Fully Shrouded, Silver, Through Hole - Solder, Sealable, LEAVYSEAL



Datasheets & Catalog Pages

ICT Terminals and Connectors Catalogue

English

Product Specifications

Application Specification

German